

Industry First Low Capacitance ESD Protection Arrays with Backdrive Protection

Product Description

The CM1223 family of diode arrays has been designed to provide ESD protection for electronic components or subsystems requiring minimal capacitive loading. These devices are ideal for protecting systems with high data and clock rates or for circuits requiring low capacitive loading. Each ESD channel consists of a pair of diodes in series, which steer the positive or negative ESD current pulse to either the positive (V_P) or negative (V_N) supply rail. A Zener diode is embedded between V_P and V_N , to absorb positive ESD strikes and provide ESD protection for the V_P rail. An additional diode is integrated to serve as backdrive current protection. The CM1223 protects against ESD pulses up to ± 8 kV per the IEC 61000-4-2 standard. In addition, all pins are protected from contact discharges of greater than ± 15 kV as outlined by the MIL-STD-883D (Method 3015) specification for Human Body Model (HBM) ESD.

These devices are particularly well-suited for protecting systems using high-speed ports such as USB2.0, IEEE1394 (Firewire[®], iLink[™]), serial ATA, DVI, HDMI and corresponding ports in removable storage, digital camcorders, DVD-RW drives, as well as other applications where extremely low loading capacitance with ESD protection are required in a small package footprint.

Features

- Two, Four, and Eight Channels of ESD Protection with Integrated Backdrive Protection on all Lines
- Provides ESD Protection to IEC61000-4-2 Level 4: ± 8 kV Contact Discharge & ± 15 kV Air Discharge
- Low Channel Input Capacitance of 1.0 pF (typical)
- Minimal Capacitance Change with Temperature and Voltage
- Channel I/O to GND Capacitance Difference of 0.02 pF Typical is Ideal for Differential Signals
- Mutual Capacitance between Signal Pin and Adjacent Signal Pin at 0.11 pF (typical)
- Zener Diode Protects Supply Rail and Eliminates the Need for External Bypass Capacitors
- Pin Compatible with CM1213-02, -04, and -08
- Each I/O Pin Can Withstand over 1000 ESD Strikes
- Available in SOT, and MSOP Packages
- These Devices are Pb-Free and are RoHS Compliant

Applications

- USB 2.0 Ports at 480 Mbps in Desktop PCs, Notebooks and Peripherals
- IEEE1394 Firewire[®] Ports at 400 Mbps / 800 Mbps
- DVI Ports, HDMI Ports in Notebooks, Set Top Boxes, Digital TVs, LCD Displays



ON Semiconductor[®]

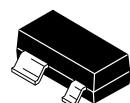
<http://onsemi.com>



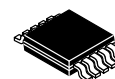
SOT23-5
SO SUFFIX
CASE 527AH



SOT23-6
SO SUFFIX
CASE 527AJ



SOT-143
SR SUFFIX
CASE 318A

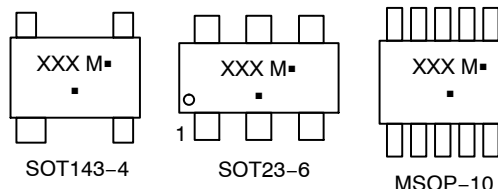


MSOP 10
MR SUFFIX
CASE 846AE

BLOCK DIAGRAM

(see page 2)

MARKING DIAGRAM



SOT143-4 SOT23-6 MSOP-10

XXX = Specific Device Code
M = Date Code
▪ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

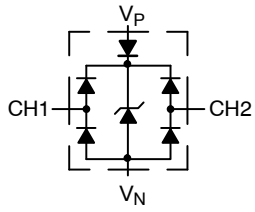
Device	Package	Shipping
CM1223-02SO	SOT23-5 (Pb-Free)	3000/Tape & Reel
CM1223-02SR	SOT143-4 (Pb-Free)	3000/Tape & Reel
CM1223-04SO	SOT23-6 (Pb-Free)	3000/Tape & Reel
CM1223-04MR	MSOP-10 (Pb-Free)	4000/Tape & Reel
CM1223-08MR	MSOP-10 (Pb-Free)	4000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

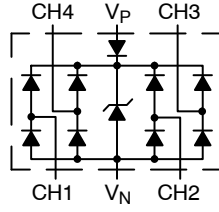
- UDI and Display Ports
- Serial ATA Ports in Desktop PCs and Hard Disk Drives
- PCI Express Ports
- General Purpose High-speed Data Line ESD Protection

CM1223

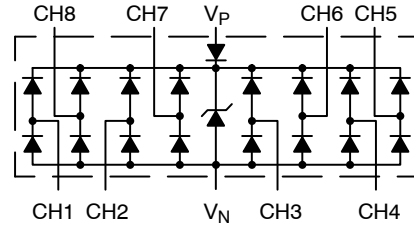
BLOCK DIAGRAM



CM1223-02SO
CM1223-02SR



CM1223-04SO
CM1223-04MR



CM1223-08MR

Table 1. PIN DESCRIPTIONS

2-Channel, 5-Lead SOT23-5 Package			
Pin	Name	Type	Description
1	NC		No Connect
2	V _N	GND	Negative voltage supply rail
3	CH1	I/O	ESD Channel
4	CH2	I/O	ESD Channel
5	V _P	PWR	Positive voltage supply rail

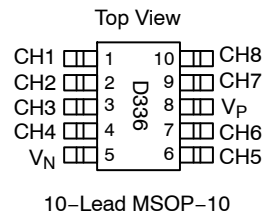
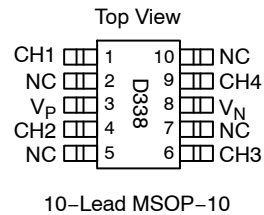
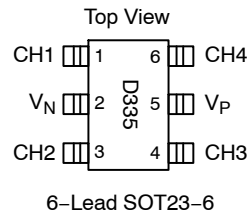
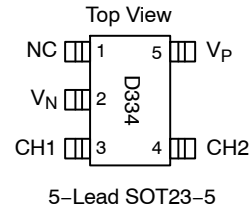
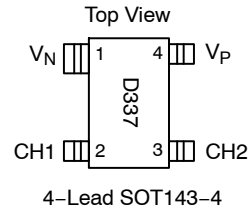
2-Channel, 4-Lead SOT143-4 Package			
Pin	Name	Type	Description
1	V _N	GND	Negative voltage supply rail
2	CH1	I/O	ESD Channel
3	CH2	I/O	ESD Channel
4	V _P	PWR	Positive voltage supply rail

4-Channel, 6-Lead SOT23-6 Package			
Pin	Name	Type	Description
1	CH1	I/O	ESD Channel
2	V _N	GND	Negative voltage supply rail
3	CH2	I/O	ESD Channel
4	CH3	I/O	ESD Channel
5	V _P	PWR	Positive voltage supply rail
6	CH4	I/O	ESD Channel

4-Channel, 10-Lead MSOP-10 Package			
Pin	Name	Type	Description
1	CH1	I/O	ESD Channel
2	NC		No Connect
3	V _P	PWR	Positive voltage supply rail
4	CH2	I/O	ESD Channel
5	NC		No Connect
6	CH3	I/O	ESD Channel
7	NC		No Connect
8	V _N	GND	Negative voltage supply rail
9	CH4	I/O	ESD Channel
10	NC		No Connect

8-Channel, 10-Lead MSOP-10 Package			
Pin	Name	Type	Description
1	CH1	I/O	ESD Channel
2	CH2	I/O	ESD Channel
3	CH3	I/O	ESD Channel
4	CH4	I/O	ESD Channel
5	V _N	GND	Negative voltage supply rail
6	CH5	I/O	ESD Channel
7	CH6	I/O	ESD Channel
8	V _P	PWR	Positive voltage supply rail
9	CH7	I/O	ESD Channel
10	CH8	I/O	ESD Channel

PACKAGE / PINOUT DIAGRAMS



CM1223

SPECIFICATIONS

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameter	Rating	Units
Operating Supply Voltage ($V_P - V_N$)	6.0	V
Operating Temperature Range	-40 to +85	°C
Storage Temperature Range	-65 to +150	°C
DC Voltage at any channel input	$(V_N - 0.5)$ to $(V_P + 0.5)$	V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. STANDARD OPERATING CONDITIONS

Parameter	Rating	Units
Operating Temperature Range	-40 to +85	°C
Package Power Rating SOT143-4 Package (CM1223-02SR) SOT23-5 Package (CM1223-02SO) SOT23-6 Package (CM1223-04SO) MSOP-10 Package (CM1223-04MR) MSOP-10 Package (CM1223-08MR)	225 225 225 400 400	mW

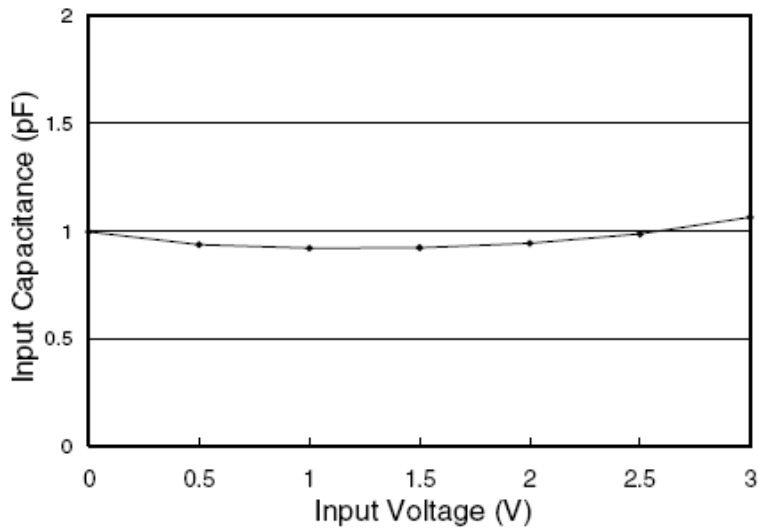
Table 4. ELECTRICAL OPERATING CHARACTERISTICS (Note1)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
V_P	Operating Supply Voltage ($V_P - V_N$)			3.3	5.5	V
I_P	Operating Supply Current	$(V_P - V_N) = 3.3$ V			8.0	μA
V_{SCL}	Signal Clamp Voltage Positive Transients Negative Transients	$I_F = 8$ mA; $T_A = 25^\circ\text{C}$	6.7 0.60	8.2 0.80		V
I_{LEAK}	Channel Leakage Current	$T_A = 25^\circ\text{C}$; $V_P = 5$ V, $V_N = 0$ V		±0.1	±1.0	μA
C_{IN}	Channel Input Capacitance	At 1 MHz, $V_P = 3.3$ V, $V_N = 0$ V, $V_{IN} = 1.65$ V		1.0	1.5	pF
ΔC_{IN}	Channel Input Capacitance Matching	At 1 MHz, $V_P = 3.3$ V, $V_N = 0$ V, $V_{IN} = 1.65$ V		0.02		pF
C_{MUTUAL}	Mutual Capacitance between signal pin and adjacent signal pin	At 1 MHz, $V_P = 3.3$ V, $V_N = 0$ V, $V_{IN} = 1.65$ V		0.11		pF
V_{ESD}	ESD Protection – Peak Discharge Voltage at any channel input, in system a) Contact discharge per IEC 61000-4-2 standard b) Human Body Model, MIL-STD-883, Method 3015	$T_A = 25^\circ\text{C}$; (Notes 3 and 4) $T_A = 25^\circ\text{C}$; (Notes 2 and 4)		±8 ±15		kV
V_{CL}	Channel Clamp Voltage Positive Transients Negative Transients	$T_A = 25^\circ\text{C}$, $I_{PP} = 1$ A, $t_P = 8/20$ μS (Note 4)		+8.8 -1.4		V
R_{DYN}	Dynamic Resistance Positive Transients Negative Transients	$T_A = 25^\circ\text{C}$, $I_{PP} = 1$ A, $t_P = 8/20$ μS Any I/O pin to Ground (Note 4)		0.7 0.4		Ω

- All parameters specified at $T_A = -40^\circ\text{C}$ to $+85^\circ\text{C}$ unless otherwise noted.
- Human Body Model per MIL-STD-883, Method 3015, $C_{Discharge} = 100$ pF, $R_{Discharge} = 1.5$ kΩ, $V_P = 3.3$ V, V_N grounded.
- Standard IEC 61000-4-2 with $C_{Discharge} = 150$ pF, $R_{Discharge} = 330$ Ω, $V_P = 3.3$ V, V_N grounded.
- These measurements performed with no external capacitor on V_P (V_P floating).

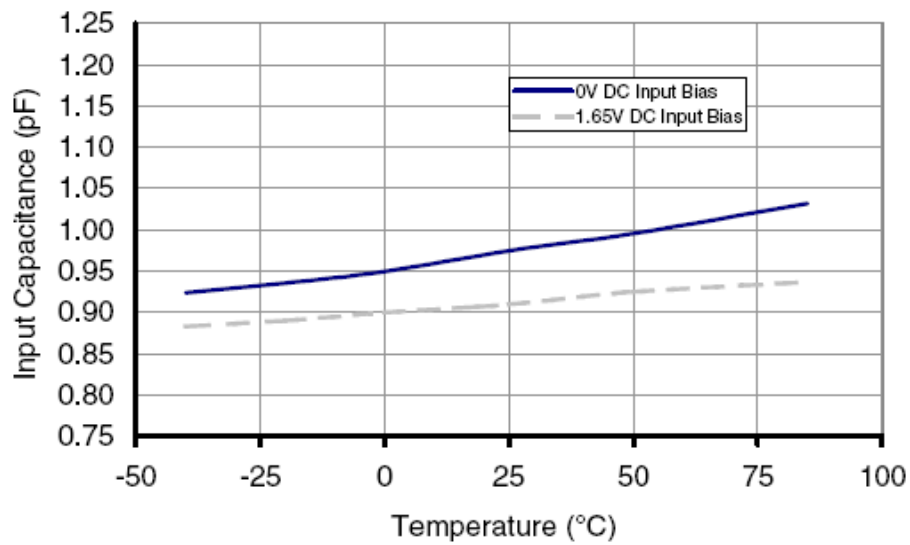
PERFORMANCE INFORMATION

Input Channel Capacitance Performance Curves



Typical Variation of C_{IN} vs. V_{IN}

($f=1\text{MHz}$, $V_P = 3.3\text{V}$, $V_N = 0\text{V}$, $0.1 \mu\text{F}$ chip capacitor between V_P and V_N , 25°C)



Typical Variation of C_{IN} vs. Temp

($f=1\text{MHz}$, $V_{IN}=30\text{mV}$, $V_P = 3.3\text{V}$, $V_N = 0\text{V}$, $0.1 \mu\text{F}$ chip capacitor between V_P and V_N)

CM1223

PERFORMANCE INFORMATION (Cont'd)

Typical Filter Performance (nominal conditions unless specified otherwise, 50 Ohm Environment)

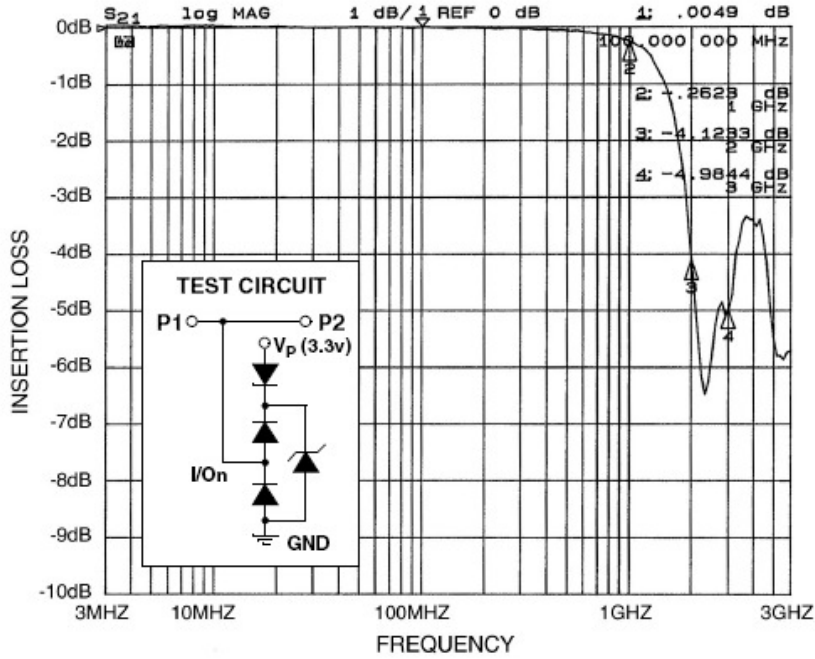


Figure 1. Insertion Loss (S₂₁) vs. Frequency (0 V DC Bias, V_p=3.3 V, MSOP-10 Package)

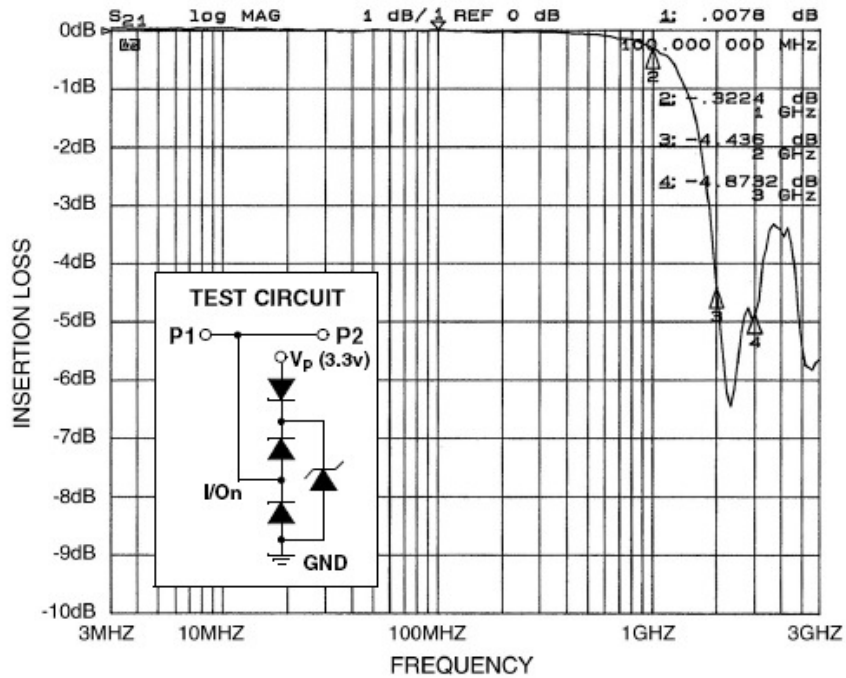


Figure 2. Insertion Loss (S₂₁) vs. Frequency (2.5 V DC Bias, V_p=3.3 V, MSOP-10 Package)

BACKDRIVE PROTECTION

Backdrive protection is needed to block against backdrive current flowing from a high potential voltage node toward a lower potential voltage node through the interface cable.

For example, consider a DVD player connected to a TV via an HDMI interface. If the DVD player is switched off and the TV is left on, there is a possibility of reverse current flow back into the main power supply rail of the DVD player. Typically, the DVD's power supply has some form of associated bulk supply capacitance, and it is possible over time to charge that bulk supply capacitance to some intermediate level.

If that level rises above the power-on-reset (POR) voltage level of some of the integrated circuits, the DVD player may not reset properly when the DVD player is turned back on. This is largely because all CMOS logic exhibits a very high impedance on the power rail node even when "off".

To avoid this situation, the CM1223 with integrated backdrive protection diode was designed to block backdrive current, guaranteeing no more than 5 μA on any I/O pin when the I/O pin voltage is greater than the CM1223 supply voltage.

APPLICATION INFORMATION

Design Considerations

To realize the maximum protection against ESD pulses, care must be taken in the PCB layout to minimize parasitic series inductances on the Supply/Ground rails as well as the signal trace segments between the signal input (typically a connector) and the ESD protection device. Application of Positive ESD Pulse between Input Channel and Ground illustrates an example of a positive 8 kV ESD pulse striking an input channel. The 8 kV ESD current pulse will divert along the path as indicated in Application of Positive ESD Pulse between Input Channel and Ground, through the D1 diode and the Zener diode back to the ground rail.

An ESD current pulse can rise from zero to its peak value in a very short time. For example, a level 4 contact discharge per the IEC61000-4-2 standard results in a current pulse that rises from zero to 30 Amps in 1ns. The CM1223 has a fast response time of less than 1ns and low clamp voltage to handle this pulse scenario.

Similarly for negative ESD pulses, parasitic series inductance from the V_N pin to the ground rail will lead to drastically increased negative voltage on the line being protected.

The CM1223 also has an integrated backdrive diode between V_P and V_N to prevent backdrive current flow from the powered sources.

As a general rule, the ESD Protection Array should be located as close as possible to the point of entry of expected electrostatic discharges.

ADDITIONAL INFORMATION

See also ON Semiconductor Application Note “Design Considerations for ESD Protection”, in the Applications section.

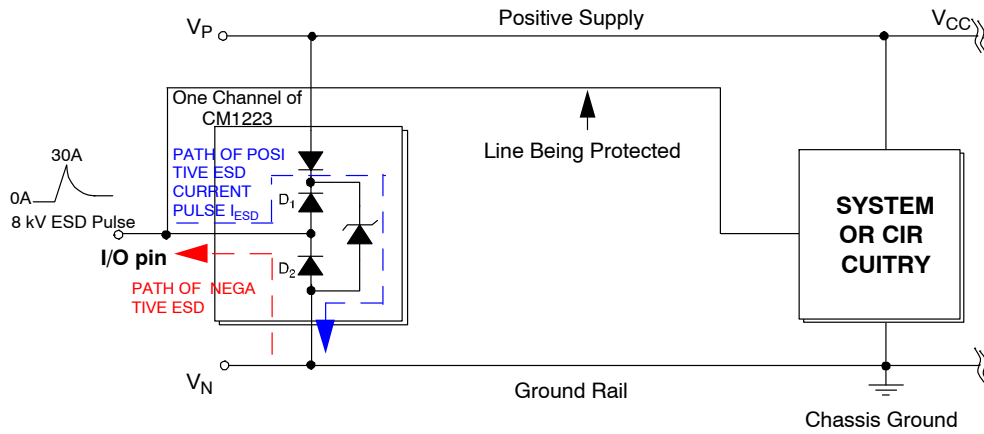


Figure 3. Application of Positive ESD Pulse between Input Channel and Ground

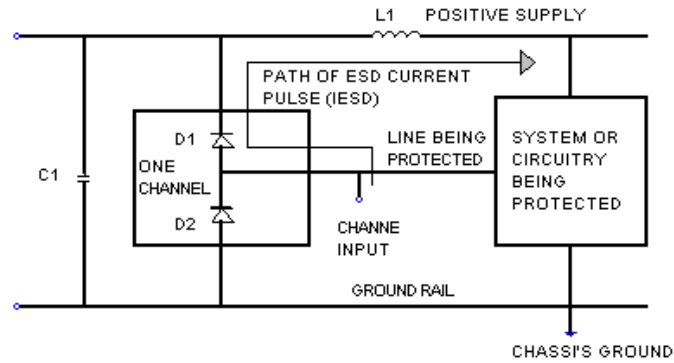


Figure 4. Application of Positive ESD Pulse between Input Channel and Ground

CM1223

MECHANICAL DETAILS

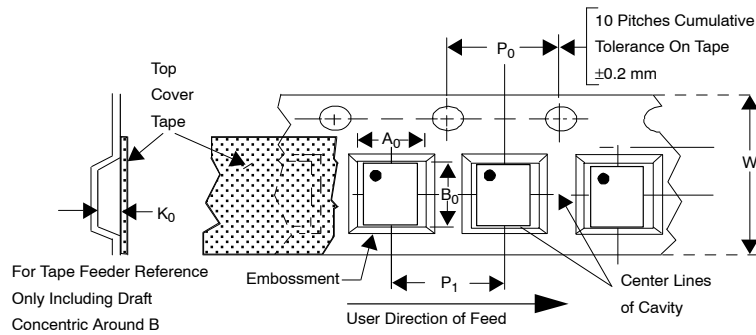
The CM1223 is available in SOT143-4, SOT23-5, SOT23-6, and MSOP-10 packages with a lead-free finishing. The various package drawings are presented below.

SOT143 Mechanical Specifications

The CM1223-02SR is supplied in 4-pin SOT143 package, the CM1223-02SO in a 5-pin SOT23 package, the CM1223-04SO in a 6-pin SOT23 package, and the CM1223-08MR in a 10-lead MSOP package. Dimensions are presented below.

Table 5. TAPE AND REEL SPECIFICATIONS

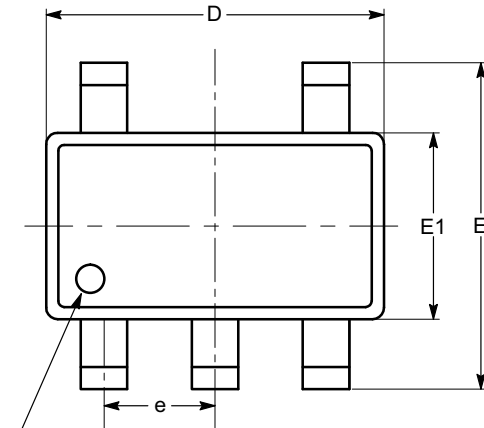
Part Number	Chip Size (mm)	Pocket Size (mm) $B_0 \times A_0 \times K_0$	Tape Width W	Reel Diameter	Qty per Reel	P_0	P_1
CM1223-02SR	2.92 X 2.37 X 1.01	2.60 X 3.15 X 1.20	8 mm	178 mm (7")	3000	4 mm	4 mm
CM1223-02SO	2.90 X 2.80 X 1.45	3.20 X 3.20 X 1.40	8 mm	178 mm (7")	3000	4 mm	4 mm
CM1223-04SO	2.90 X 2.80 X 1.45	3.20 X 3.20 X 1.40	8 mm	178 mm (7")	3000	4 mm	4 mm
CM1223-08MR	3.00 X 3.00 X 0.85	3.30 X 5.30 X 1.30	12 mm	330 mm (13")	4000	4 mm	8 mm



CM1223

PACKAGE DIMENSIONS

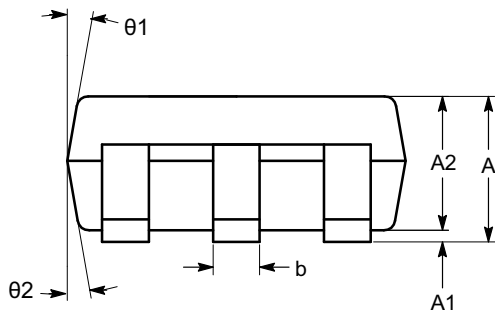
SOT-23, 5 Lead
CASE 527AH-01
ISSUE O



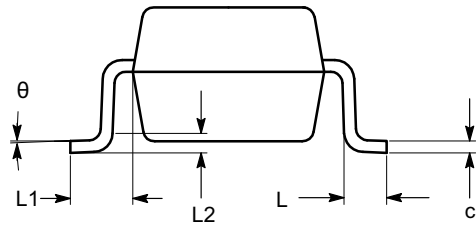
PIN #1 IDENTIFICATION

TOP VIEW

SYMBOL	MIN	NOM	MAX
A	0.90		1.45
A1	0.00		0.15
A2	0.90	1.15	1.30
b	0.30		0.50
c	0.08		0.22
D	2.90 BSC		
E	2.80 BSC		
E1	1.60 BSC		
e	0.95 BSC		
L	0.30	0.45	0.60
L1	0.60 REF		
L2	0.25 REF		
θ	0°	4°	8°
$\theta 1$	5°	10°	15°
$\theta 2$	5°	10°	15°



SIDE VIEW



END VIEW

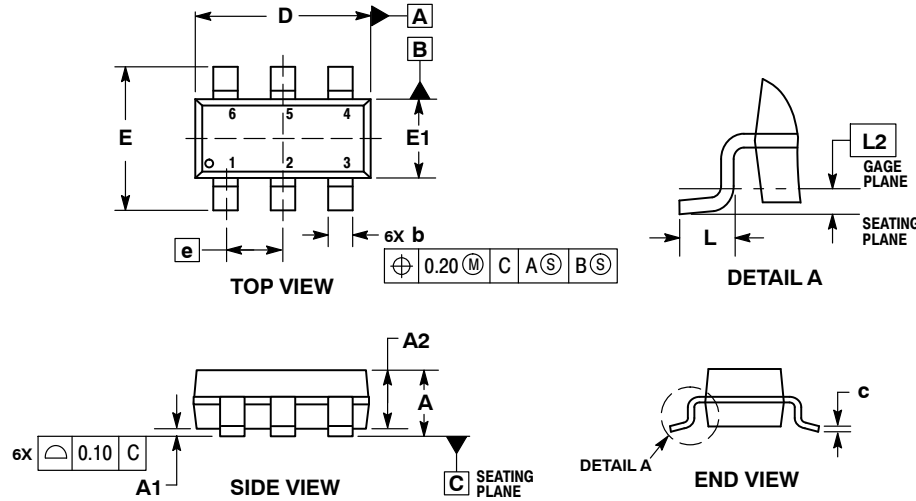
Notes:

- (1) All dimensions in millimeters. Angles in degrees.
- (2) Complies with JEDEC standard MO-178.

CM1223

PACKAGE DIMENSIONS

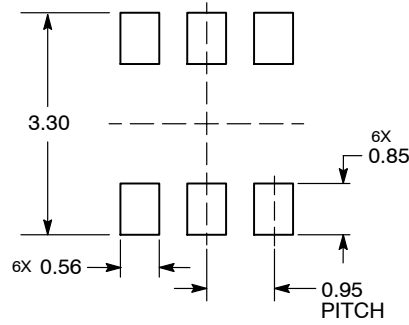
SOT-23, 6 Lead
CASE 527AJ
ISSUE B



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.
 3. DATUM C IS THE SEATING PLANE.

MILLIMETERS		
DIM	MIN	MAX
A	---	1.45
A1	0.00	0.15
A2	0.90	1.30
b	0.20	0.50
c	0.08	0.26
D	2.70	3.00
E	2.50	3.10
E1	1.30	1.80
e	0.95 BSC	
L	0.20	0.60
L2	0.25 BSC	

RECOMMENDED SOLDERING FOOTPRINT*



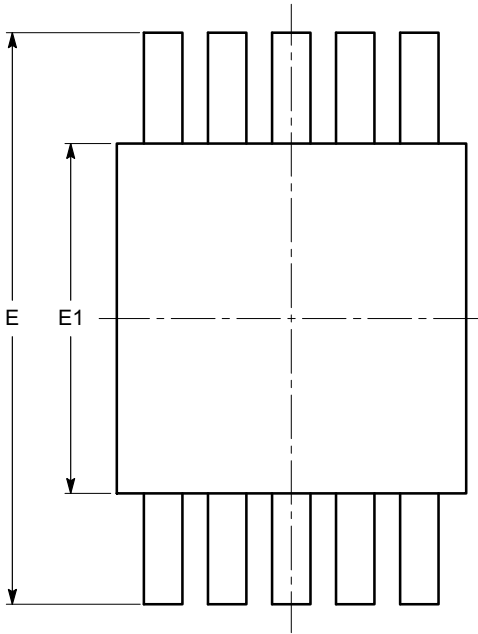
DIMENSIONS: MILLIMETERS

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

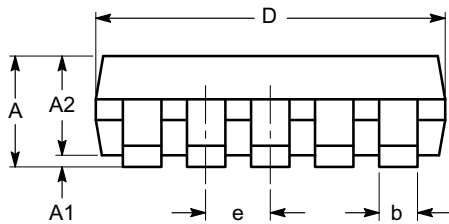
CM1223

PACKAGE DIMENSIONS

MSOP 10, 3x3
CASE 846AE-01
ISSUE O

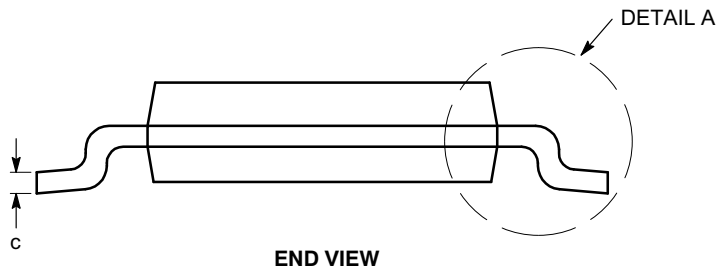


TOP VIEW

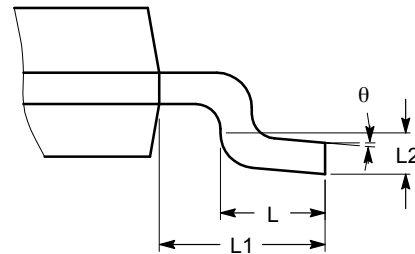


SIDE VIEW

SYMBOL	MIN	NOM	MAX
A			1.10
A1	0.00	0.05	0.15
A2	0.75	0.85	0.95
b	0.17		0.27
c	0.13		0.23
D	2.90	3.00	3.10
E	4.75	4.90	5.05
E1	2.90	3.00	3.10
e	0.50 BSC		
L	0.40	0.60	0.80
L1	0.95 REF		
L2	0.25 BSC		
θ	0°		8°



END VIEW



DETAIL A

Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-187.

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- Поставка оригинальных импортных электронных компонентов напрямую с производств Америки, Европы и Азии, а так же с крупнейших складов мира;
- Широкая линейка поставок активных и пассивных импортных электронных компонентов (более 30 млн. наименований);
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Помощь Конструкторского Отдела и консультации квалифицированных инженеров;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Поставка электронных компонентов под контролем ВП;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- При необходимости вся продукция военного и аэрокосмического назначения проходит испытания и сертификацию в лаборатории (по согласованию с заказчиком);
- Поставка специализированных компонентов военного и аэрокосмического уровня качества (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Actel, Aeroflex, Peregrine, VPT, Syfer, Eurofarad, Texas Instruments, MS Kennedy, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Компания «Океан Электроники» является официальным дистрибьютором и эксклюзивным представителем в России одного из крупнейших производителей разъемов военного и аэрокосмического назначения «JONHON», а так же официальным дистрибьютором и эксклюзивным представителем в России производителя высокотехнологичных и надежных решений для передачи СВЧ сигналов «FORSTAR».



JONHON

«JONHON» (основан в 1970 г.)

Разъемы специального, военного и аэрокосмического назначения:

(Применяются в военной, авиационной, аэрокосмической, морской, железнодорожной, горно- и нефтедобывающей отраслях промышленности)

«FORSTAR» (основан в 1998 г.)

ВЧ соединители, коаксиальные кабели, кабельные сборки и микроволновые компоненты:

(Применяются в телекоммуникациях гражданского и специального назначения, в средствах связи, РЛС, а так же военной, авиационной и аэрокосмической отраслях промышленности).



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